

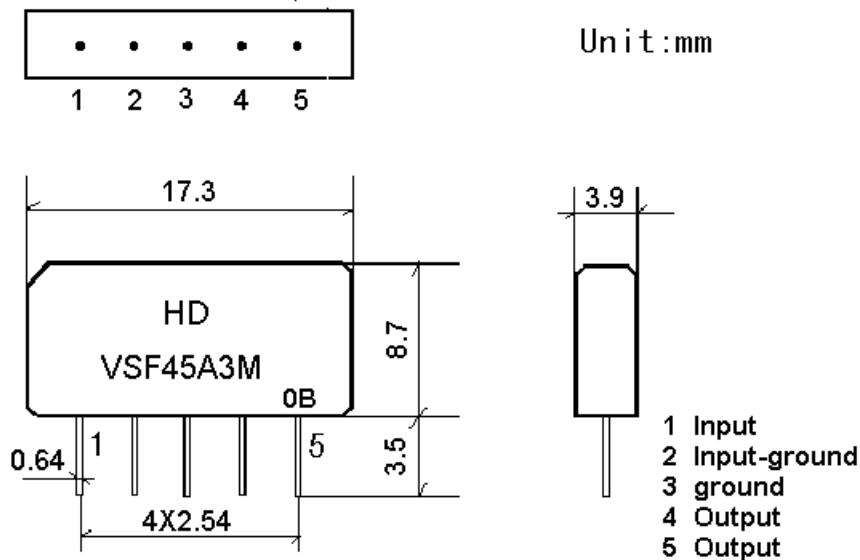
1. SCOPE

The SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. They are used in electronic equipments such as TV and so on.

2. Construction

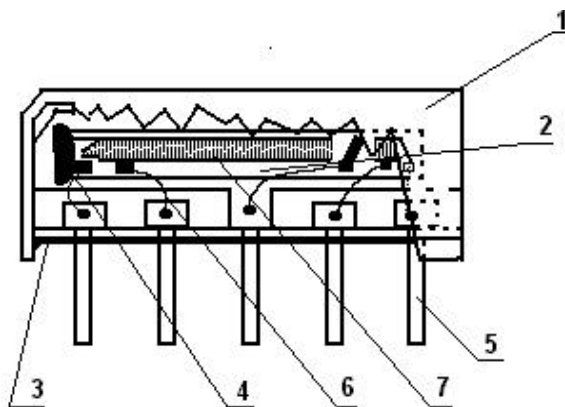
2.1 Dimension and materials

Type: VSF45A3M



0: year(0,1,2,3,4,5,6,7,8,9)

B:product in this quarter(A:1~3,B:4~6,C:7~9,D:10~12)



Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

3. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows;

- Ambient temperature : 15 to 35
- Relative humidity : 25% to 85%
- Air pressure : 86kPa to 106kPa

Operating temperature range

Operating temperature range is the range of ambient temperatures in which the filter can be operated continuously. -10 ~ +60

Storage temperature range

Storage temperature range is the range of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. -40 ~ +70

Reference temperature +25

3.1 Maximum Rating

DC voltage	VDC	12	V	Between any terminals
AC voltage	Vpp	10	V	Between any terminals

3.2 Electrical Characteristics

Source impedance $Z_s=50$

Load impedance $Z_L=50$

$T_A=25$

Item	Freq	min	typ	max	
Insertion attenuation Reference level	43.50MHz	22.0	24.0	26.0	dB
Relative attenuation	45.75MHz	-1.8	-0.3	1.2	dB
	46.50MHz	1.0	2.5	4.0	dB
	41.25MHz	-1.7	-0.2	1.3	dB
	39.75MHz	29.0	37.0		dB

	47.25MHz	29.0	38.0		dB
Sidelobe	35.00~39.25MHz	26.0	30.0		dB
	47.75~55.00MHz	26.0	32.0		dB
Temperature coefficient		-72			ppm/k

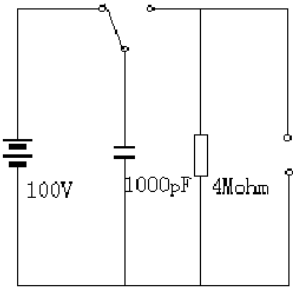
3.3 Environmental Performance Characteristics

Item Test condition	Allowable change of absolute Level at center frequency(dB)
High temperature test 70 1000H	< 1.0
Low temperature test -40 1000H	< 1.0
Humidity test 40 90-95% 1000H	< 1.0
Thermal shock -20 ==25 ==80 20 cycle 30M 10M 30M	< 1.0
Solder temperature test Sold temp.260 for 10 sec.	< 1.0
Soldering Immerse the pins melt solder at 260 +5/-0 for 5 sec.	More then 95% of total area of the pins should be covered with solder

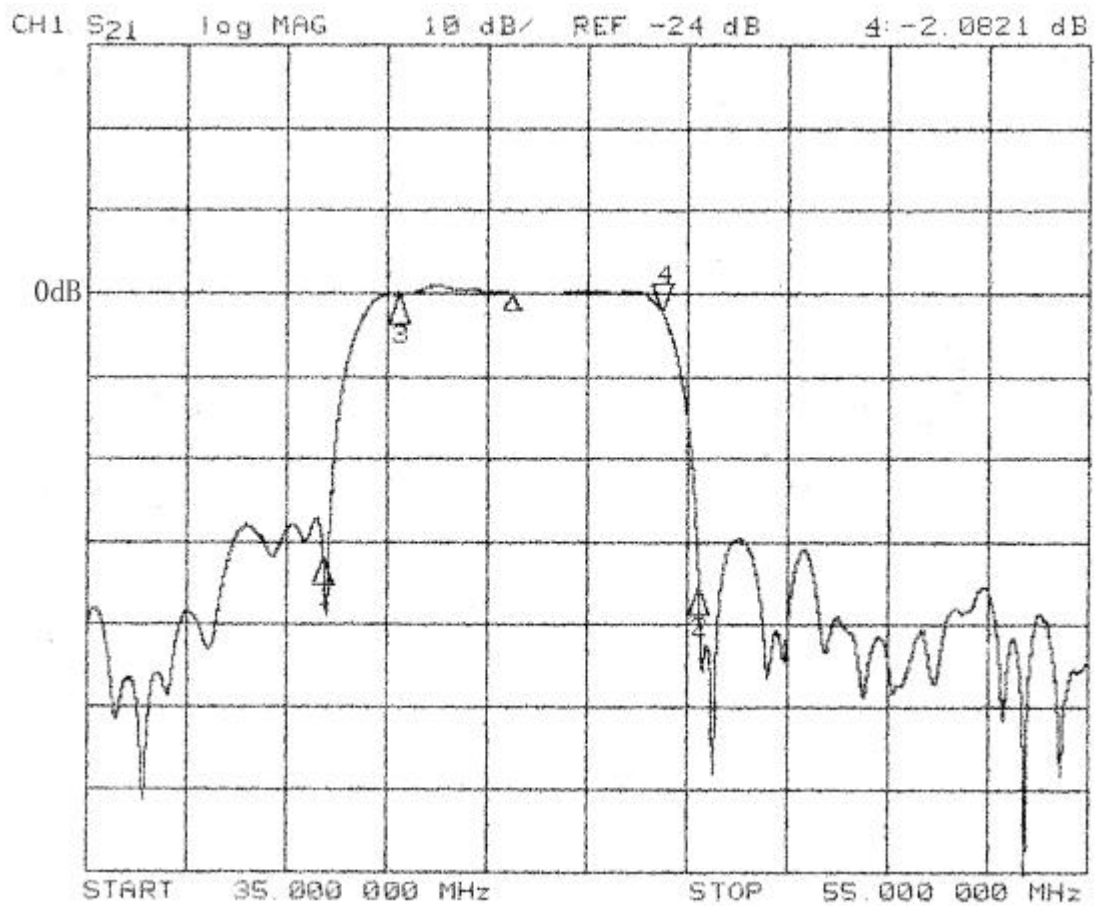
3.4 Mechanical Test

Item Test condition	Allowable change of absolute Level at center frequency(dB)
Vibration test 600-3300rpm amplitude 1.5mm 3 directions 2 H each	<1.0
Drop test On maple plate from 1 m high 3 times	<1.0
Lead pull test Pull with 1 kg force for 30 seconds	<1.0
Lead bend test 90° bending with 500g weigh 2 times	<1.0

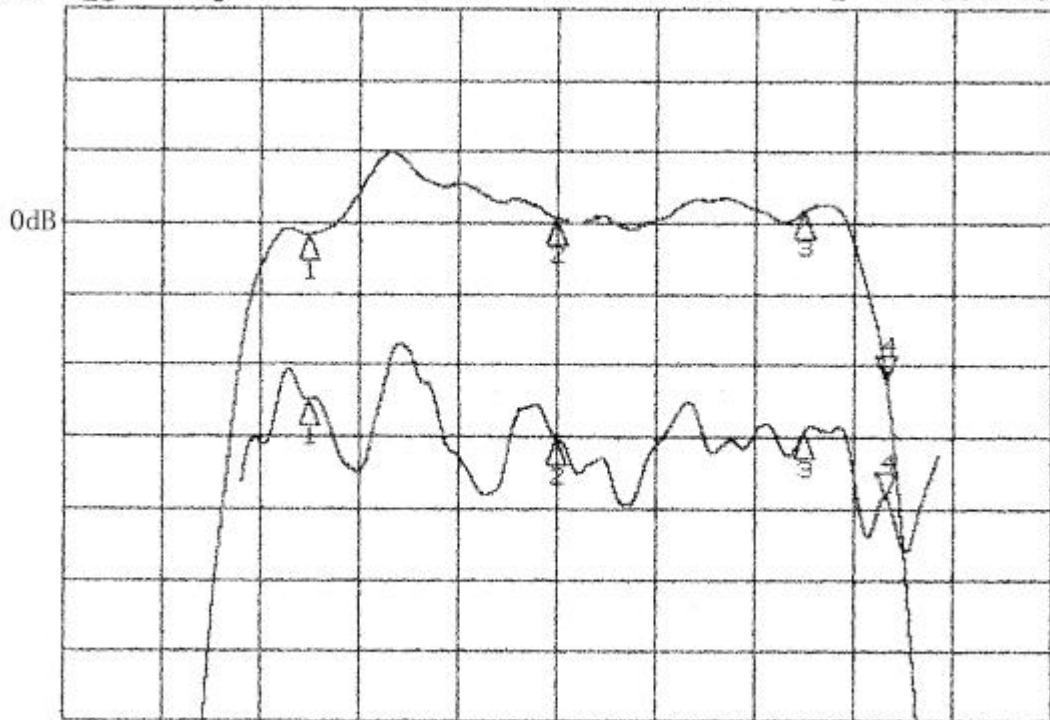
3.5 Voltage Discharge Test

Item Test condition	Allowable change of absolute Level at center frequency(dB)
Surge test Between any two electrode 	<1.0

3.6 Frequency response

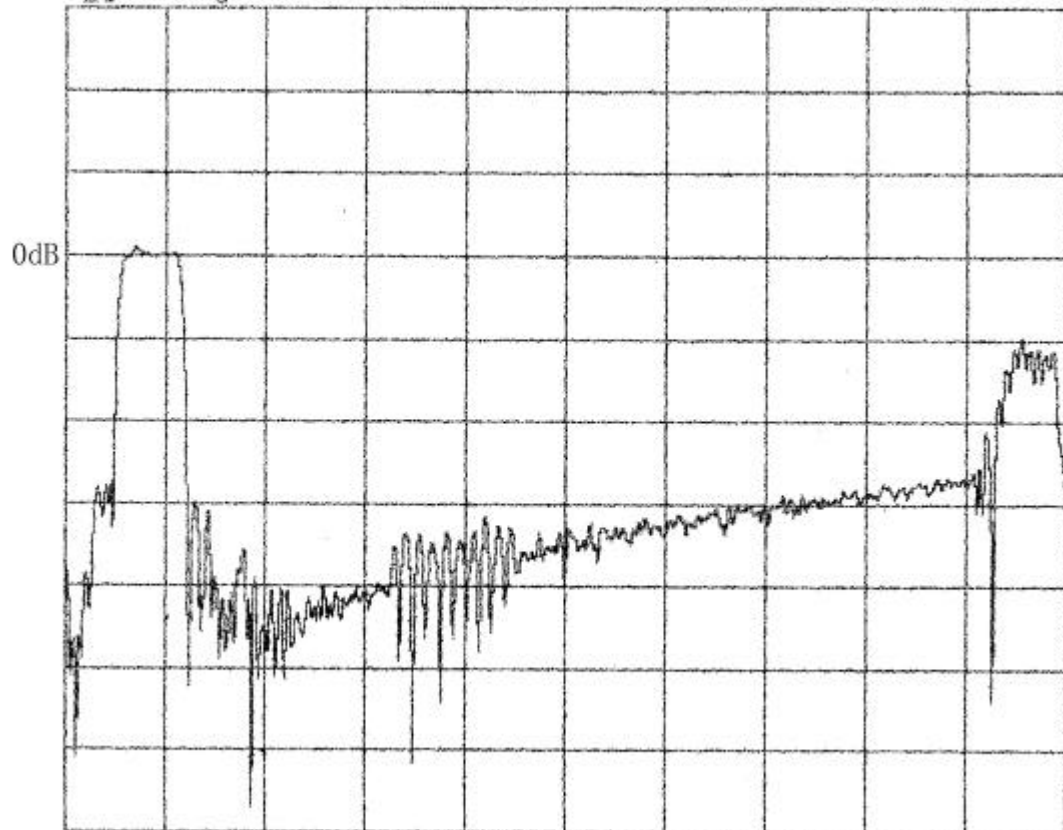


CH1 S21 delay 50 ns/ REF 1.438 μ s 4 1.2457 μ s
CH2 S21 log MAG 1 dB/ REF -24 dB 4 -26.223 dB



START 39.800 000 MHz STOP 48.000 000 MHz

CH1 S21 log MAG 10 dB/ REF -24 dB



START 35.000 000 MHz STOP 135.000 000 MHz